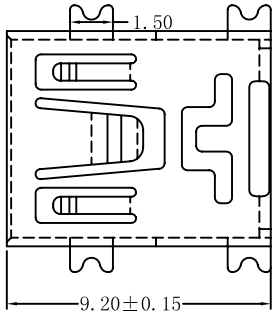
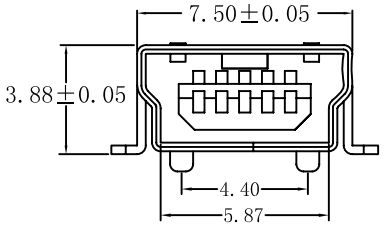
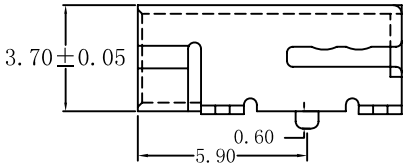
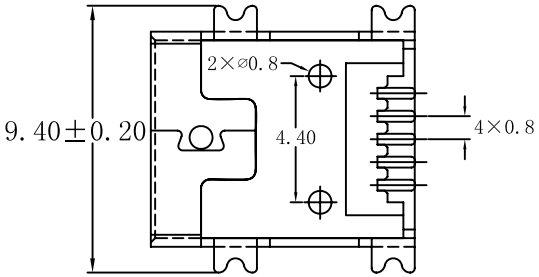
由 Autodesk 教育版产品制作

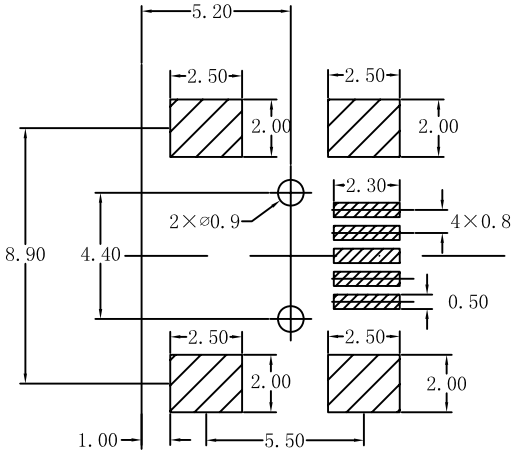
目錄 MAPX	设变内容 MODIFICATION	日期 DATE











RECOMMENDED PCB LAYOUT

规格:Specifications:
电器:Electrical:
接触阻抗:Contact Resistance
50 milliohms MAX
耐电压:Dielectric Withstanding Voltage:
100 V AC AT Sea LevoL
绝缘阻抗:Insulation Resistance:
100 MEGA ohms MIN
材料:Matorial:
塑胶:Housing:Hing Temperature Thermoplastics,
UL 94V-0 耐高温塑胶
端子:Contact: Copper Alloy 铜合金
外壳:Shell: Copper Alloy 铜合金
电镀:Finish:
外壳:Shell:
Nickel/ Plating 镀镍
端子:Contact: Piated Gold in Mating Area;
Tin On Solder Talls
接触点镀金.脚镀锡

Ordering Informating

X - 5 - XX

Contact plating
01-Gold Flash
02-5u"Gold/ Tin
03-15u"Gold/ Tin
04-30u"Gold/Tin

X

Plastic Color
A=Black

尺寸未注公差参考±0.10

产品图
PRODUCT CHART DWG

公差一览表
TOLERANCE UNLESS OTHERWISE

X.	±0.25	X°.	±5°
.X	±0.20	.X°	±2°
.XX	±0.15	.XX°	±1°
.XXX	±0.10	.XXX°	±0.5°

单位 UNITS	MM	制图 DRAWING	Z-Y-B	产品料号 PRODUCT PART NO.	
比例 SCALE	1:1	审核 CHKD	雷永键	产品名称 PRODUCT NO.	MINI 5P 母头 SMT
日期 DATE	2009/10/20	核准 APPD	雷永键	角法 VIEW	版本 VER A0

由 Autodesk 教育版产品制作
由 Autodesk 教育版产品制作
由 Autodesk 教育版产品制作